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| | First Named Inventor Shun | | unpu Li | | |
| | Art Unit | | 4111 | | |
| | Examiner Name | Brown | | | |
| | Attorney Docket Numb | er | 05-372 | | |

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| Examiner Name | Brown | Brown | | | | | |
| Attorney Docket Number | | 05-372 | | | | | |

| | 1 | Kahp Y. Suh et al., "Capillary Force Lithography: Large-Area Patterning, Self-Organization, and Anisotropy Wetting," Adv. Funct. Mater., vol. 12, no. 6+7, pp. 405-413 (June 2002) | | | | | | | | |
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